

# 2SD1264, 2SD1264A

Silicon NPN triple diffusion planar type

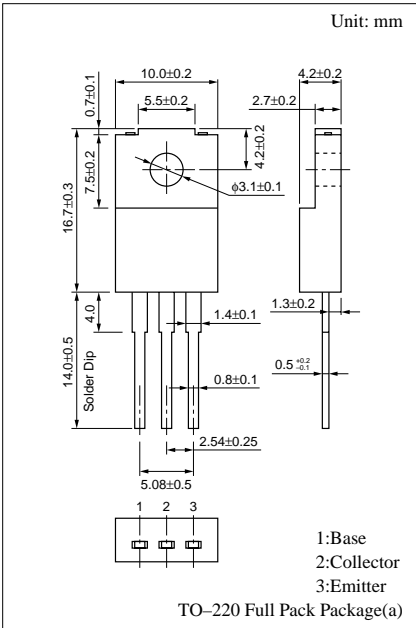
For low-frequency power amplification  
 For TV vertical deflection output  
 Complementary to 2SB0940 (2SB940) and 2SB0940A (2SB940A)

## Features

- High collector to emitter  $V_{CEO}$
- Large collector power dissipation  $P_C$
- Full-pack package which can be installed to the heat sink with one screw

## Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ )

Parameter	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	200	V
Collector to emitter voltage	$V_{CEO}$	150	V
2SD1264A		180	
Emitter to base voltage	$V_{EBO}$	6	V
Peak collector current	$I_{CP}$	3	A
Collector current	$I_C$	2	A
Collector power dissipation	$T_C=25^\circ\text{C}$	30	W
	$T_a=25^\circ\text{C}$	2	
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$



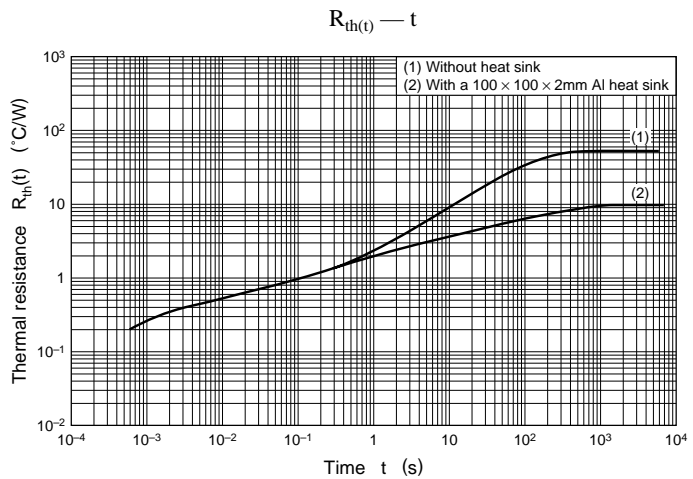
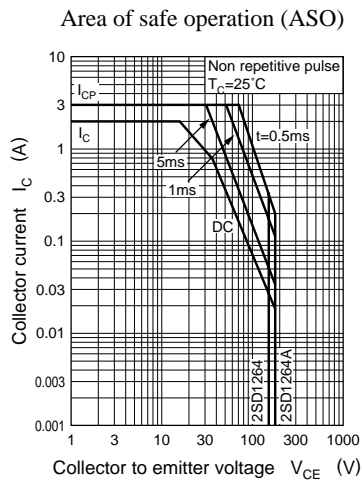
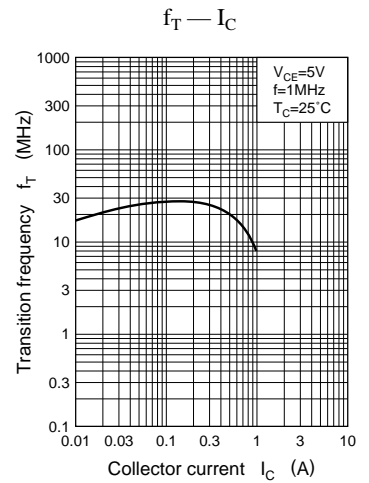
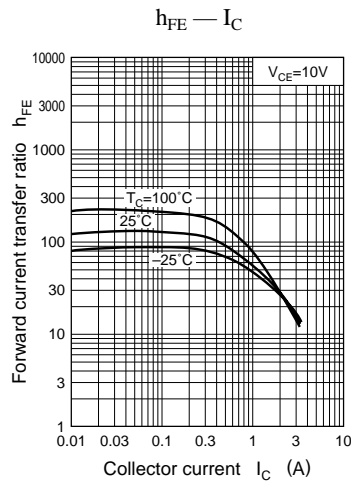
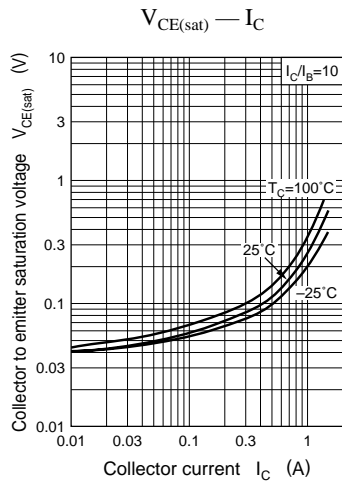
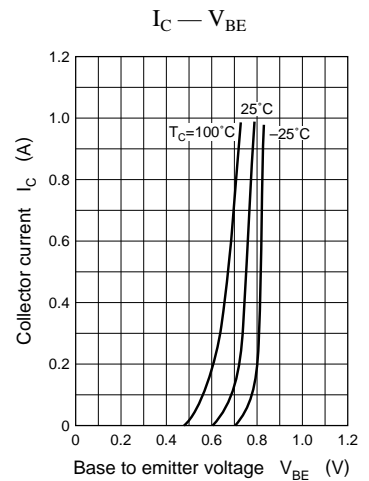
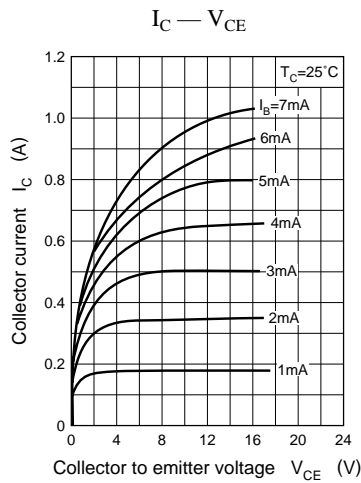
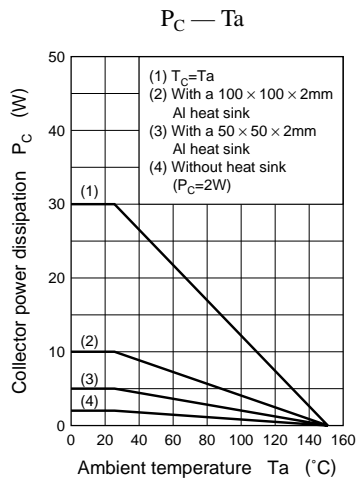
## Electrical Characteristics ( $T_C=25^\circ\text{C}$ )

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 200\text{V}, I_E = 0$			50	$\mu\text{A}$
Emitter cutoff current	$I_{EBO}$	$V_{EB} = 4\text{V}, I_C = 0$			50	$\mu\text{A}$
Collector to base voltage	$V_{CBO}$	$I_C = 50\mu\text{A}, I_E = 0$	200			V
Collector to emitter voltage	$V_{CEO}$	$I_C = 5\text{mA}, I_B = 0$	150			V
			180			
Emitter to base voltage	$V_{EBO}$	$I_E = 500\mu\text{A}, I_C = 0$	6			V
Forward current transfer ratio	$h_{FE1}^*$	$V_{CE} = 10\text{V}, I_C = 150\text{mA}$	60		240	
	$h_{FE2}$	$V_{CE} = 10\text{V}, I_C = 400\text{mA}$	50			
Base to emitter voltage	$V_{BE}$	$V_{CE} = 10\text{V}, I_C = 400\text{mA}$			1	V
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 500\text{mA}, I_B = 50\text{mA}$			1	V
Transition frequency	$f_T$	$V_{CE} = 5\text{V}, I_C = 0.5\text{A}, f = 1\text{MHz}$		20		MHz

\* $h_{FE1}$  Rank classification

Rank	Q	P
$h_{FE1}$	60 to 140	100 to 240

Note) The part numbers in the parenthesis show conventional part number.



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